- 1. (Original) A system-on-a-chip integrated circuit structure comprising:
  - a bridge having a plurality of channels;
- a processor local bus connected to said bridge, wherein said bridge includes a first channel dedicated to said processor local bus;
  - at least one logic device connected to said processor local bus;
- a peripheral device bus connected to said bridge, wherein said bridge includes a second channel dedicated to said peripheral device bus;
  - at least one peripheral device connected to said peripheral device bus;
- at least one memory unit connected to said bridge, wherein said bridge includes a third channel dedicated to said memory unit; and
- at least one input/output unit connected to said bridge, wherein said bridge includes a fourth channel dedicated to said input/output unit.
- 2. (Original) The structure in claim 1, wherein each of said channels includes buffer memories adapted to store data when a previous data transfer is being performed.
- 3. (Original) The structure in claim 2, wherein said buffer memories comprise first-in first-out buffer memories.
- 4. (Original) The structure in claim 1, wherein each of said channels includes a multi- port static random access memory (SRAM) adapted to store data when a previous data transfer is being performed.
- 5. (Original) The structure in claim 1, wherein each of said channels includes a multiplexor adapted to selectively connect to other channels.
- 6. (Original) The structure in claim 1, wherein said at least one memory unit comprises a first-type memory unit and a second-type memory unit different than said

first-type memory unit, wherein said third channel is dedicated to said first-type memory unit and said bridge includes a fifth channel dedicated to said second-type memory unit.

- 7. (Original) The structure in claim 6, wherein said first-type memory unit comprises static random access memory (SRAM) and said second-type memory unit comprises synchronous dynamic random access memory (SDRAM).
- 8. (Original) The structure in claim 1, wherein said at least one input/output unit comprises one or more of a peripheral interface, graphics interface, and serial bus interface, and wherein said bridge includes dedicated channels for each of said peripheral interface, graphics interface, and serial bus interface.
- 9. (Original) The structure in claim 1, wherein said at least one peripheral device includes one or more of a serial connection, network interface connection, and programmable input/output connection each connected to said peripheral device bus.
- 10. (Original) Λ system-on-a-chip integrated circuit structure comprising:

   a bridge having a plurality of channels;
   at least one bus connected to a unique dedicated channel in said bridge;
   at least one memory unit connected to a unique dedicated channel in said bridge;

  and
- at least one input/output unit connected to a unique dedicated channel in said bridge.
- 11. (Original) The structure in claim 10, wherein said at least one bus includes: a processor local bus connected to said bridge, wherein said bridge includes a first channel dedicated to said processor local bus; and
- a peripheral device bus connected to said bridge, wherein said bridge includes a second channel dedicated to said peripheral device bus,

wherein said structure further comprises:

at least one logic device connected to said processor local bus; and at least one peripheral device connected to said peripheral device bus.

- (Original) The structure in claim 10, wherein each of said channels includes 12. buffer memories adapted to store data when a previous data transfer is being performed.
- (Original) The structure in claim 12, wherein said buffer memories comprise 13. first-in first-out buffer memories.
- (Original) The structure in claim 10, wherein each of said channels includes a 14. multi- port static random access memory (SRAM) adapted to store data when a previous data transfer is being performed.
- (Original) The structure in claim 10, wherein each of said channels includes a 15. multiplexor adapted to selectively connect to other channels.
- (Original) The structure in claim 10, wherein said at least one memory unit 16. comprises a first-type memory unit and a second-type memory unit different than said first-type memory unit, wherein said bridge includes a first channel is dedicated to said first-type memory unit and a second channel dedicated to said second-type memory unit.
- The structure in claim 16, wherein said first-type memory unit 17. (Original) comprises static random access memory (SRAM) and said second-type memory unit comprises synchronous dynamic random access memory (SDRAM).
- (Original) The structure in claim 10, wherein said at least one input/output unit 18. comprises one or more of a peripheral interface, graphics interface, and serial bus interface, and wherein said bridge includes unique dedicated channels for each of said peripheral interface, graphics interface, and serial bus interface.

- 19. (Original) The structure in claim 11, wherein said at least one peripheral device includes one or more of a serial connection, network interface connection, and programmable input/output connection each connected to said peripheral device bus.
- 20. (Original) A bridge for a system-on-a-chip (SoC) integrated circuit structure comprising:
  - a plurality of dedicated channels each uniquely connected to one or more of:
  - at least one hus within said SoC;
  - at least one memory unit within said SoC;
  - at least one input/output unit within said SoC; and
  - at least one peripheral device within said SoC.
- 21. (Original) The structure in claim 20, wherein said at least one bus includes:
- a processor local bus connected to said bridge, wherein said bridge includes a first channel dedicated to said processor local bus; and
- a peripheral device bus connected to said bridge, wherein said bridge includes a second channel dedicated to said peripheral device bus,

wherein said SoC includes:

- at least one logic device connected to said processor local bus; and
- at least one peripheral device connected to said peripheral device bus.
- 22. (Original) The structure in claim 20, wherein each of said channels includes buffer memories adapted to store data when a previous data transfer is being performed.
- 23. (Original) The structure in claim 22, wherein said buffer memories comprise first-in first-out buffer memories.

- 24. (Original) The structure in claim 20, wherein each of said channels includes a multi- port static random access memory (SRAM) adapted to store data when a previous data transfer is being performed.
- 25. (Original) The structure in claim 20, wherein each of said channels includes a multiplexor adapted to selectively connect to other channels.
- 26. (Original) The structure in claim 20, wherein said at least one memory unit comprises a first-type memory unit and a second-type memory unit different than said first-type memory unit, wherein said bridge includes a first channel is dedicated to said first-type memory unit and a second channel dedicated to said second-type memory unit.
- 27. (Original) The structure in claim 26, wherein said first-type memory unit comprises static random access memory (SRAM) and said second-type memory unit comprises synchronous dynamic random access memory (SDRAM).
- 28. (Original) The structure in claim 20, wherein said at least one input/output unit comprises one or more of a peripheral interface, graphics interface, and serial bus interface, and wherein said bridge includes unique dedicated channels for each of said peripheral interface, graphics interface, and serial bus interface.
- 29. (Original) The structure in claim 21, wherein said at least one peripheral device includes one or more of a serial connection, network interface connection, and programmable input/output connection each connected to said peripheral device bus.